



To the Honorable Commissioner of Patents
Please record the attached original documents of copy **102192215**

N. BOX ASSIGNMENTS

1. Name of conveying parties:
1. Shunji ABE
2. Yuki KUDO

8.9.02

2. Name and address of receiving party:
Name: Yamaichi Electronics Co., Ltd.

11033 U.S. PTO
10/214714
08/09/02

Additional name(s) of conveying party(ies) attached? Yes No

Internal Address:

3. Nature of conveyance:

Street Address: 28-7, Nakamagome 3-chome,
Ohta-ku, Tokyo 143-8515, Japan

Assignment Merger

City:

Security Agreement Change of Name

State:

Zip Code:

Other:

Additional name(s) & Address(es) attached?

Execution Date: July 30, 2002

Yes No

4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application: July 30, 2002

A. Patent Application Number(s):

10/214714

B. Patent Number(s):

08/12/2002 SDIRETA1 00000016 10214714
02 FC:581

40.00 00

Additional numbers attached?

Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Mr. Ernest F. Chapman

6. Total number of applications and registrations involved:
1

7. Total fee (37 CFR 3.41): \$40

Enclosed (Please charge deficiency to deposit account)

Authorized to be charged to deposit account

Internal Address: FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER, L.L.P.

Street Address: 1300 I Street, N.W.

City: Washington, D.C.

State: Zip: 20005-3315

8. Deposit Account No.: 06-0916

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Ernest F. Chapman
Reg. No. 25,961

[Signature]
Signature

August 9, 2002

Date

Total number of pages including cover sheet, attachments and documents: 3

ASSIGNMENT

WHEREAS, We, the below named inventors, (hereinafter referred to as assignors, have made an invention entitled:

SOCKET FOR SEMICONDUCTOR DEVICE

for which we executed an application for United States Letters Patent concurrently herewith or filed an application for United States Letters Patent on _____
(Application No. _____); and

WHEREAS, YAMAICHI ELECTRONICS CO., LTD., a corporation of Japan, whose post office address is 28-7, Nakamagome 3-chome, Ohta-ku, Tokyo 143-8515, Japan (hereinafter referred to as assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, we, as assignors, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, our entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and we hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, WE HEREBY further covenant and agree that we will, without further consideration, communicate with assignee, its successors and assigns, any facts known to us respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

AND, WE HEREBY authorize and request the attorneys we have empowered in the Declaration and Power of Attorney in this application, to insert here in parentheses (Application No. _____, filed _____) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, we have hereunto set our hands.

First Assignor

Name: Shunji ABE
 Address: 926-144, Hazawa-cho, Kanagawa-ku, Yokohama-shi,
 Kanagawa 221-0863, Japan
 Citizenship: Japan
 Signature: *Shunji ABE*
 Date: July 30, 2002

FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER, L.L.P.

PATENT
REEL: 013183 FRAME: 0560

Second Assignor

Name: Yuki KUDO

Address: 5-37-21, Nishiohizumi, Nerima-ku, Tokyo 178-0065, Japan

Citizenship: Japan

Signature: Y. Kudo

Date: July 30, 2002